RM PTO-1595

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| 70 | the Commissioner of Patents and T 100767232 | |
| 1. | Name of conveying party(ies): | 2. Name and address of receiving purity (es): |
| ŀ | HIDEKI OYATZU | Name: Sem Corporation |
| | | Internet Address: |
| Add | tional name(s) of conveying party(ies) attached? | Street Address: 7-35, Kitashinegawa 6-Chome |
| | Yes X No | City, State and Zip: Shinagawa-ku, Tokyo, JAPAN |
| 3. | Nature of Conveyance: | |
| | <u>_</u> | Additional Name(s) & address(es) attached? |
| | Assignment Merger Security Agreement Change of Name | Yes X No |
| H | Other | |
| | | |
| | Execution Date: June 22, 1998 | |
| | | |
| 4. | Application number(s) or patent number(s): | |
| | | |
| | A. Patent Application No.(s) 09/055,565 | 8. Patent No.(s) |
| | Filed: April 6, 1998 | |
| | Additional numbers attached? | Yes (X) No |
| | ACCITION TO THE PARTY OF THE PA | |
| 5. | Name and address of party to whom correspondence concerning document should be mailed: | 6. Total number of applications and patents involved: |
| | Name: Charles P. Sammut | 7. Total fee (37 CFR 3.41):\$ 40,00 |
| | | X Enclosed |
| | Internal Address: Limbach & Limbach L.L.P. Street Address: 2001 Ferry Building | Charge any deficiencies in the enclosed fee to Deposit Account No. 12-1420 |
| | City, State, ZIP: San Francisco, California 94111 Telephone: (415) 433-4150 | Authorized to be charged to deposit account |
| | Facsimile: (415) 433-8716 | 8. Deposit account number: 12-1420 |
| | Attorney Docket No. SONY-P8381 | |
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| 9. | Statement and signature. | and the second s |
| | To the best of my knowledge and belief, the foregoing information is true and | correct and any attached copy is a true copy of the original document |
| | Charles P. Sammut, Reg. No. 28,901 | July 6, 1998 |
| | Name of Person Signing | Signature Date |
| A79 | Total number of | pages including cover sheet, attachments and document: 1 |
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| | Patent and Trademark Office, Office of Information Systems, PK.:-1000C. Wash Reduction Project, (0651-0011), Washington, D.C. 20503 | hington, D.C. 20213, and to the Office of Management and Budget, Paperwork |
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PATENT REEL: 9308 FRAME: 0799

Docket Number: SONY-P8381

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PROCESSING METHOD AND IMAGE PROCESSING APPARATUS.

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/055.565 _____, Flling Date: 4/6/1998

This assignment executed on the dates indicated below.

| HIDEKI OYAIZU | June 12,1478 |
|-------------------------------------|---|
| Name of first or sole inventor | Execution date of U.S. Patent Application |
| TOKYO, JAPAN | |
| Residence of first or sole inventor | T , , , , , , , , , , , , , , , , , , , |
| Hideke Vyanga | Tune 2 1978 |
| Signature of first or sole inventor | Date of this assignment |

PATENT REEL: 9308 FRAME: 0800

RECORDED: 07/09/1998